



**Pb-free
HEAT**

STANLEY

1112H Series

Single Color 2125 Type

Features

Package	2125(h =0.8mm) Type, Milky White resin
Product features	<ul style="list-style-type: none"> • Outer Dimension 2.0 x 1.25 x 0.8mm (L x W x H) • Temperature range Storage Temperature : -40°C~100°C Operating Temperature : -40°C~85°C • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Green : 558nm(BG),567nm(PG) Yellow Green : 572nm(PY) Yellow : 590nm(AY) Orange : 606nm(AA) Red : 647nm(BR)
Half Intensity Angle	BG : $\theta_x = 165 \text{ deg.}, \theta_y = 164 \text{ deg.}$ PG : $\theta_x = 159 \text{ deg.}, \theta_y = 156 \text{ deg.}$ PY : $\theta_x = 151 \text{ deg.}, \theta_y = 156 \text{ deg.}$ AY : $\theta_x = 155 \text{ deg.}, \theta_y = 153 \text{ deg.}$ AA : $\theta_x = 153 \text{ deg.}, \theta_y = 154 \text{ deg.}$ BR : $\theta_x = 150 \text{ deg.}, \theta_y = 150 \text{ deg.}$
Die materials	BG,PG,PY : GaP AY,AA : GaAsP BR : GaAlAs
Rank grouping parameter	Sorted by luminous intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering, TTW (Through The Wave) soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi 180\text{mm}$
ESD	More than 2kV(HBM)

Recommended Applications

Communication Machine, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength λ_d (nm)		Luminous Intensity I_v (mcd)		
				TYP.	I_f	MIN.	TYP.	I_f
BG1112H	GaP	Green	Milky White	558	20	1.6	2.7	20
PG1112H	GaP	Green		567	20	3.8	6.4	20
PY1112H	GaP	Yellow Green		572	20	7.0	11.7	20
AY1112H	GaAsP	Yellow		590	20	2.2	3.7	20
AA1112H	GaAsP	Orange		606	20	2.2	3.7	20
BR1112H	GaAlAs	Red		647	20	7.0	11.7	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings						Unit
		BG	PG	PY	AY	AA	BR	
Power Dissipation	P_d	70	70	70	70	70	57.5	mW
Forward Current	I_F	25	25	25	25	25	25	mA
Pulse Forward Current ※1	I_{FRM}	60	60	60	60	60	60	mA
Derating (Ta=25°C or higher)	ΔI_F	0.36	0.36	0.36	0.36	0.36	0.36	mA/°C
	ΔI_{FRM}	0.86	0.86	0.86	0.86	0.86	0.86	mA/°C
Reverse Voltage	V_R	4	4	4	4	4	4	V
Operating Temperature	T_{opr}	-40~+85						°C
Storage Temperature	T_{stg}	-40~+100						°C

※1 I_{FRM} Measurement condition : $t_w \leq 1\text{ms.}$, Duty $\leq 1/20$.

Electro-Optical Characteristics

(Ta=25°C)

Item	Conditions	Symbol	Characteristics							Unit
				BG	PG	PY	AY	AA	BR	
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	2.1	2.2	2.2	1.7	V
			MAX.	2.8	2.8	2.8	2.8	2.8	2.3	
Reverse Current	V _R =4V	I _R	MAX.	100	100	100	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	555	560	570	580	605	660	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	558	567	572	590	606	647	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	30	30	30	30	30	30	nm
Half Intensity Angle	I _F =20mA	2θ _{1/2}	TYP.	165(θ _x)	159(θ _x)	151(θ _x)	155(θ _x)	153(θ _x)	150(θ _x)	deg.
				164(θ _y)	156(θ _y)	156(θ _y)	153(θ _y)	154(θ _y)	150(θ _y)	

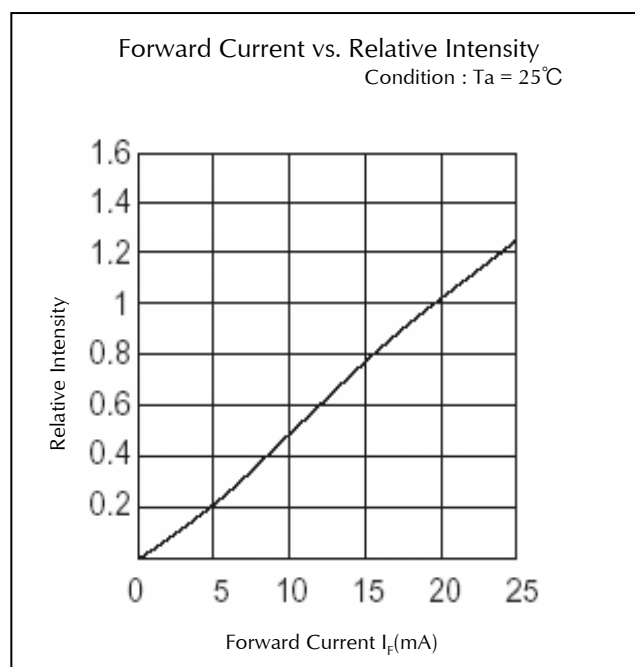
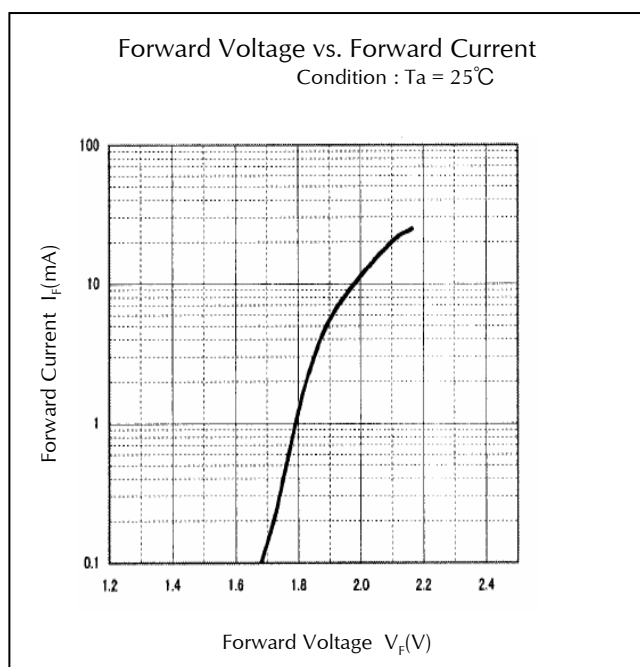
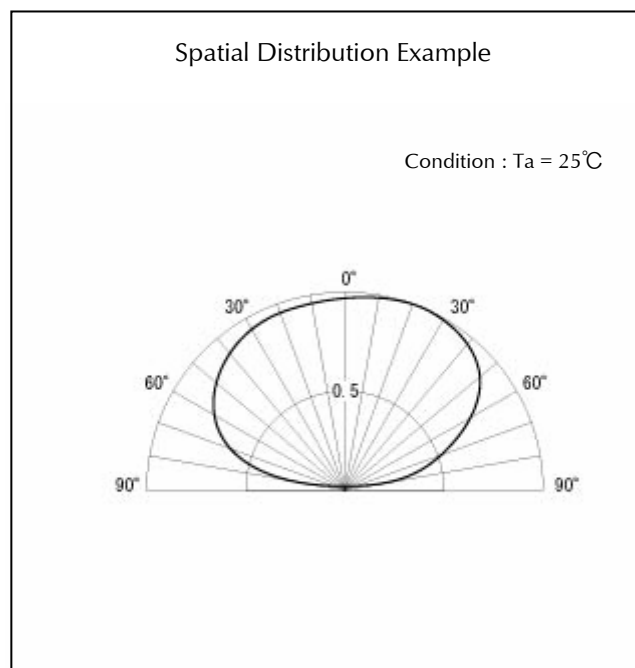
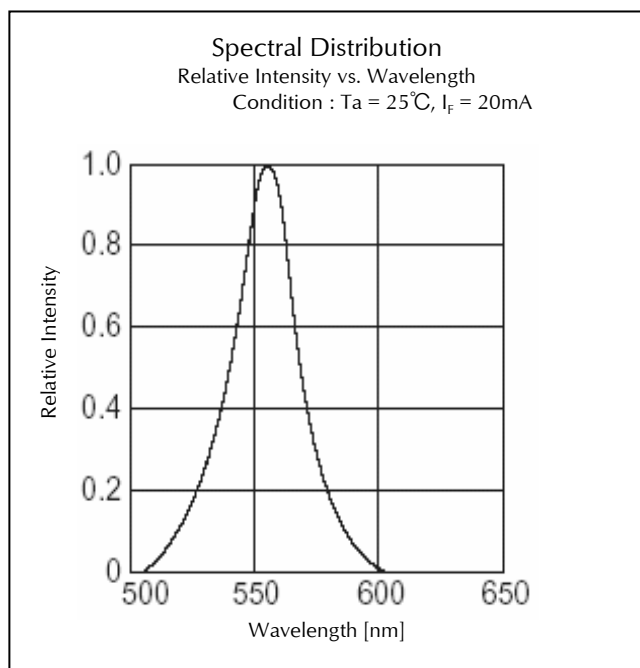
Luminous Intensity Rank

(Ta=25°C)

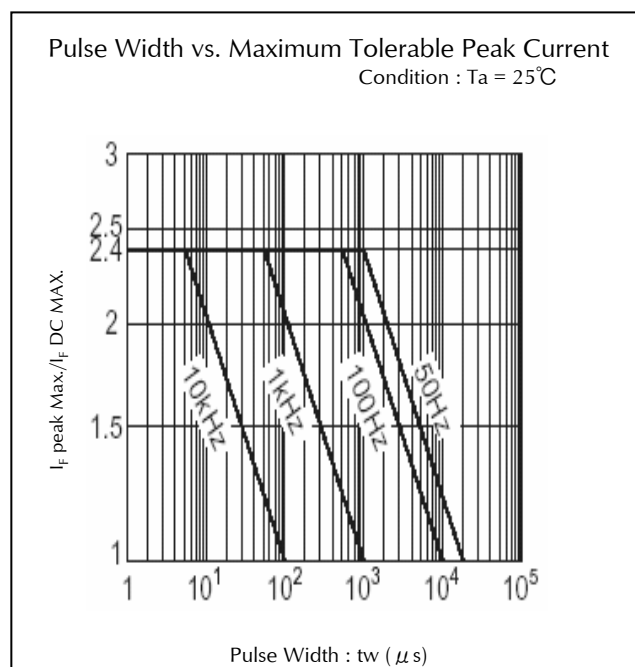
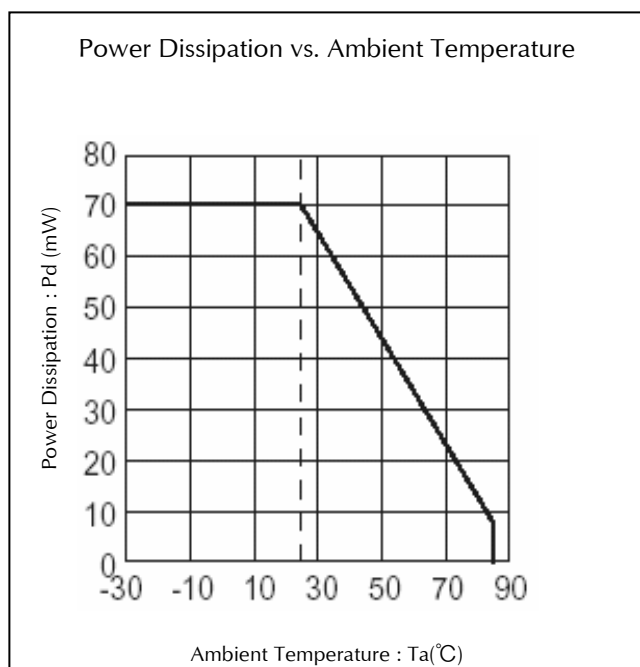
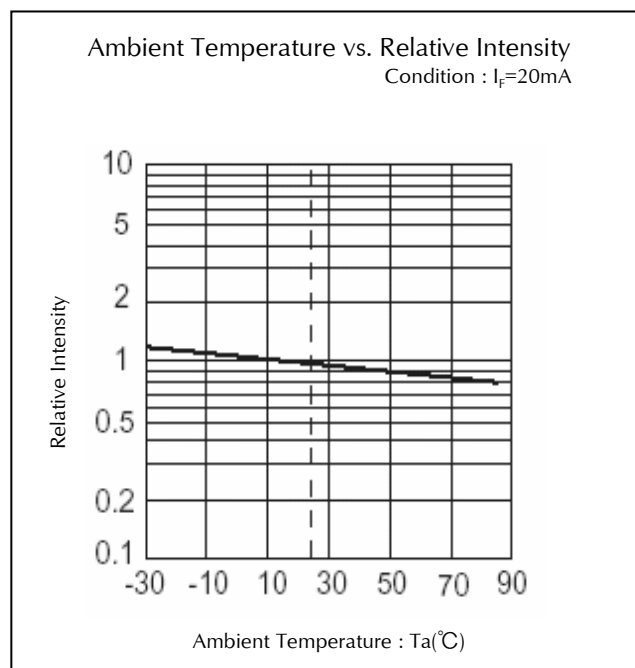
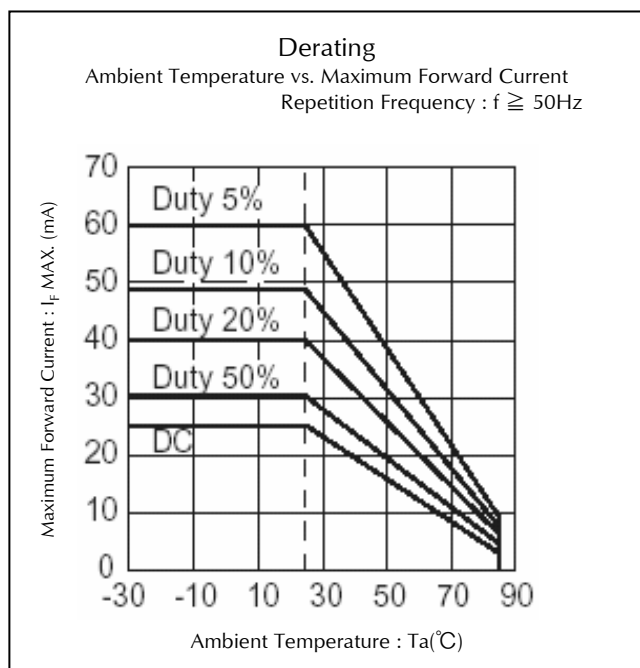
Rank	I_v (mcd)											
	BG		PG		PY		AY		AA		BR	
	$I_F=20mA$		$I_F=20mA$		$I_F=20mA$		$I_F=20mA$		$I_F=20mA$		$I_F=20mA$	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	1.6	2.3	3.8	5.4	7.0	9.9	2.2	3.1	2.2	3.1	7.0	9.9
B	1.9	2.7	4.5	6.4	8.3	11.7	2.6	3.7	2.6	3.7	8.3	11.7
C	2.3	3.3	5.4	7.6	9.9	14.0	3.1	4.4	3.1	4.4	9.9	14.0
D	2.7	3.8	6.4	9.0	11.7	16.5	3.7	5.2	3.7	5.2	11.7	16.5
E	3.3	4.7	7.6	10.7	14.0	19.8	4.4	6.2	4.4	6.2	14.0	19.8
F	3.8	-	9.0	-	16.5	-	5.2	-	5.2	-	16.5	-

Please contact our sales staff concerning rank designation.

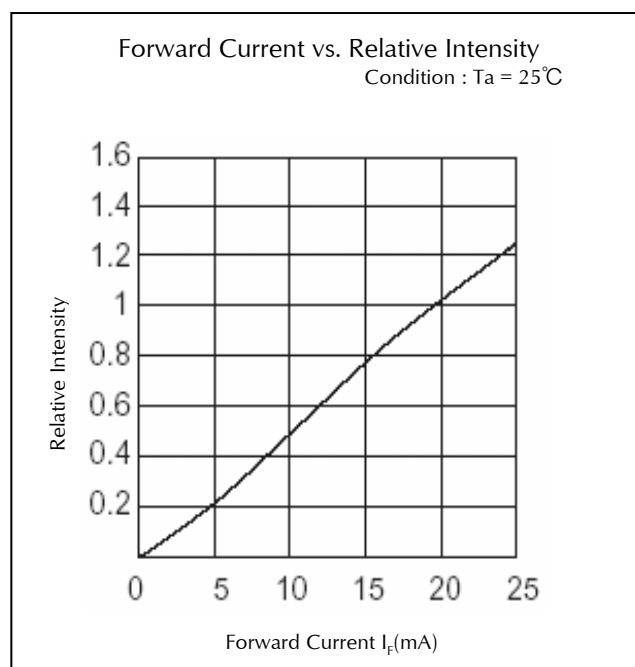
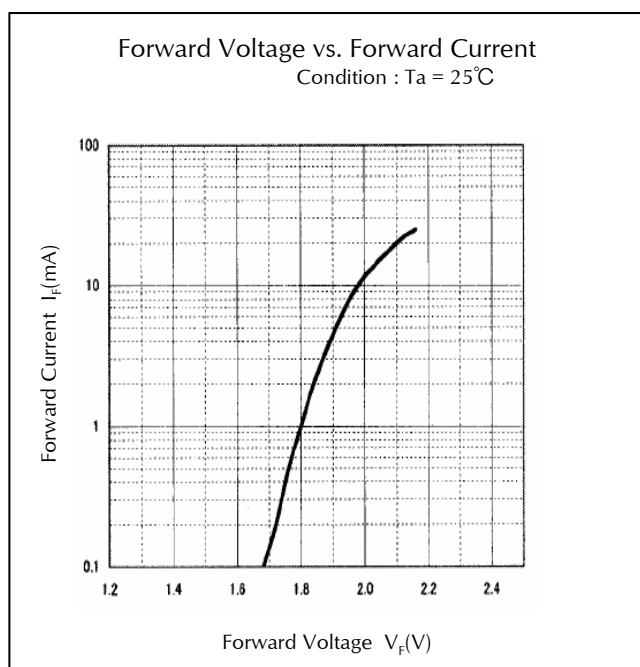
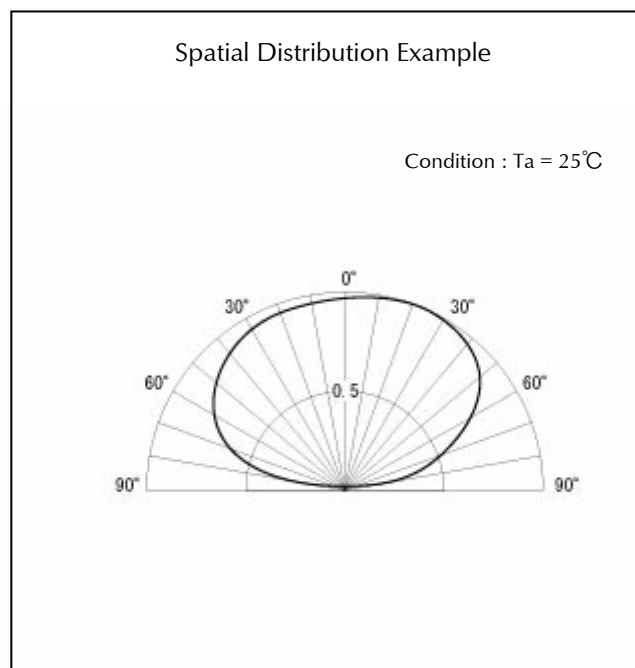
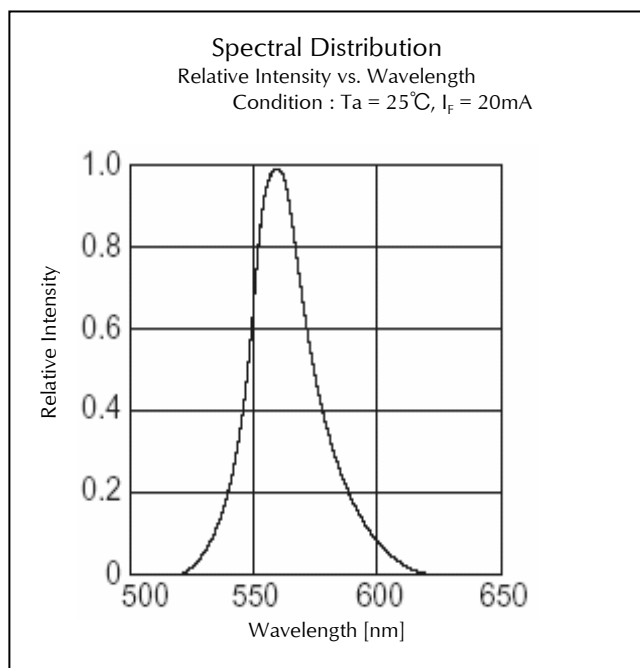
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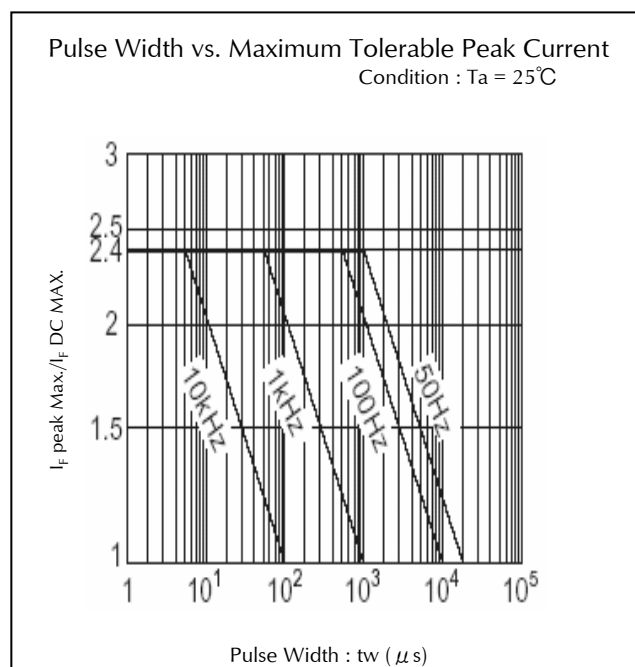
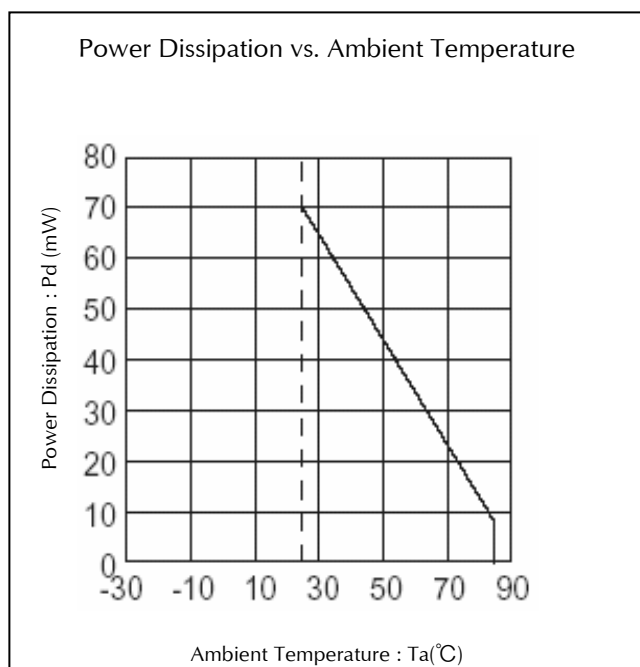
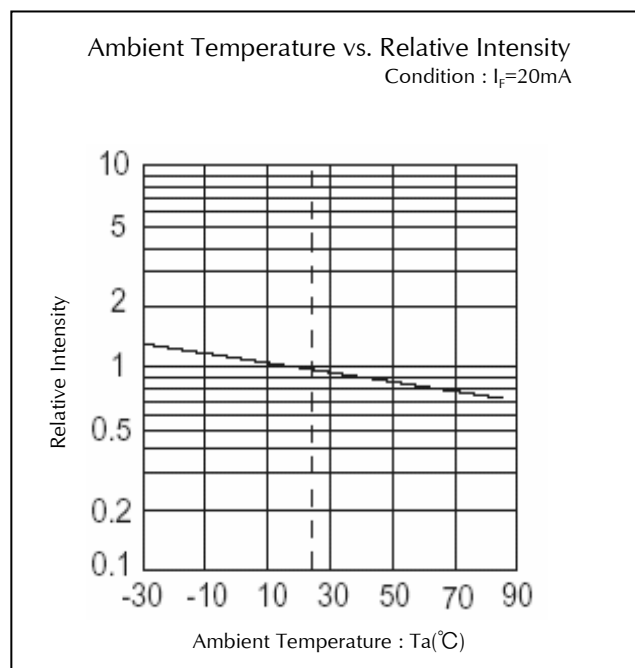
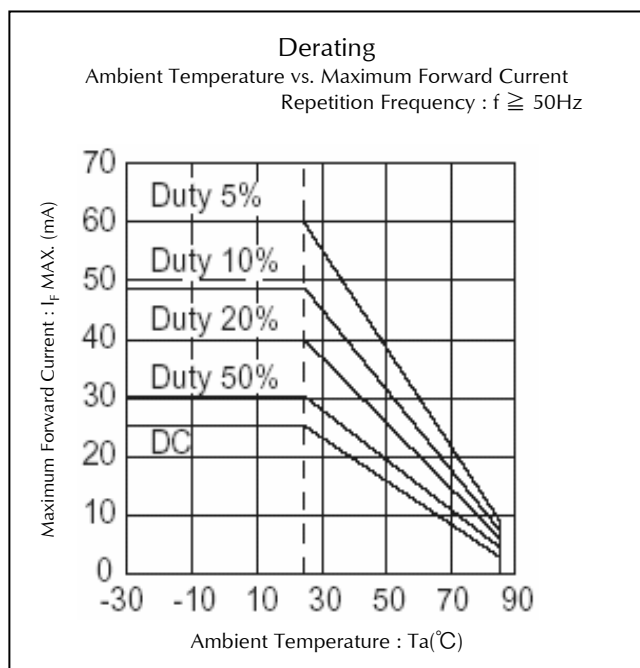
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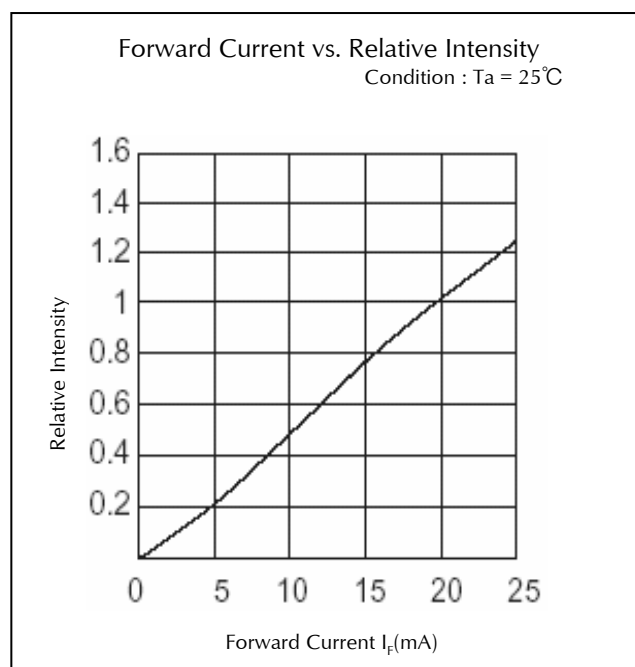
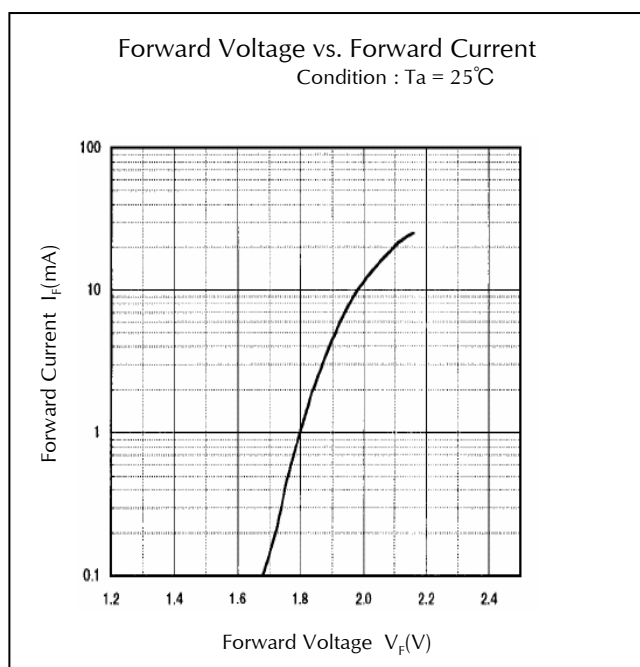
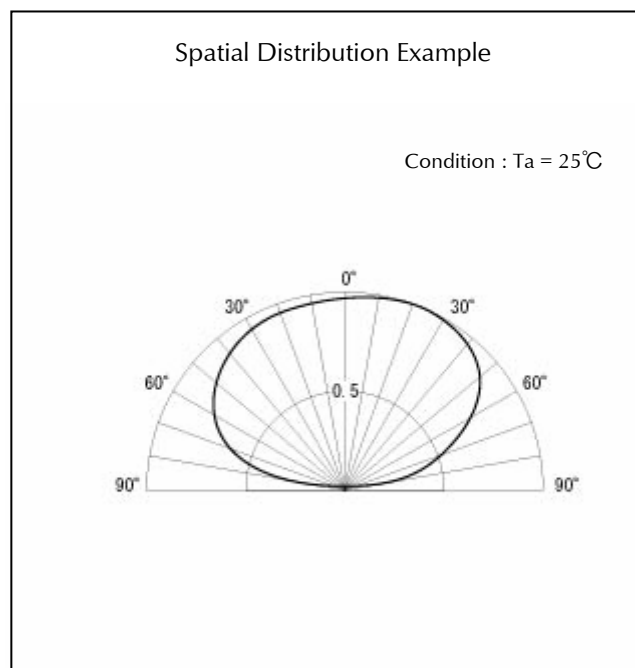
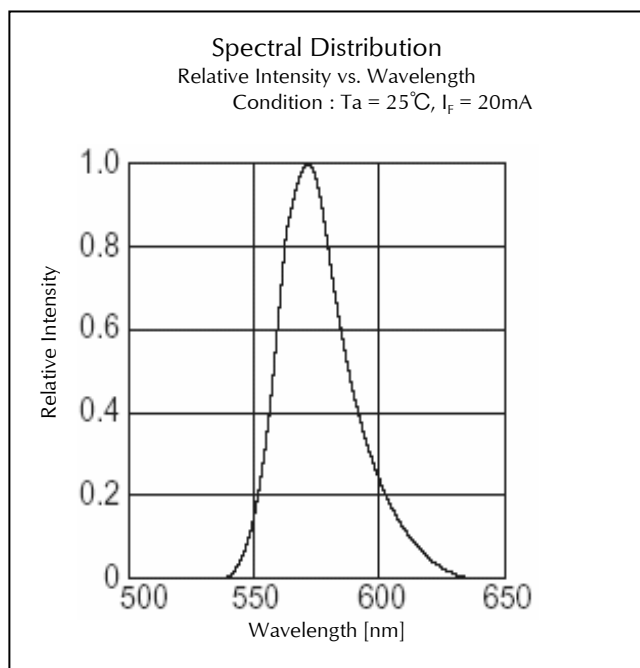
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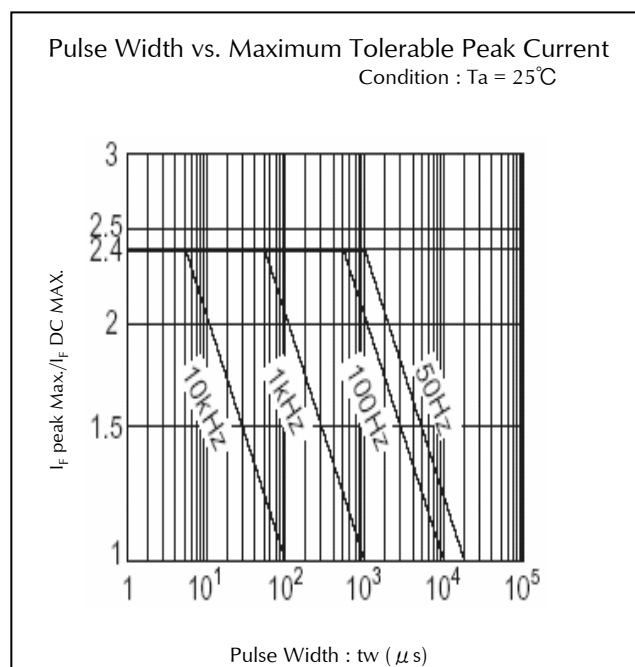
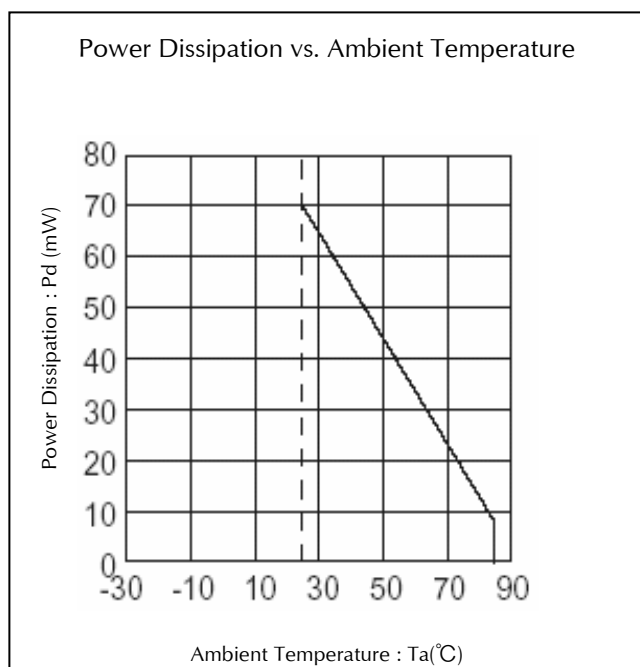
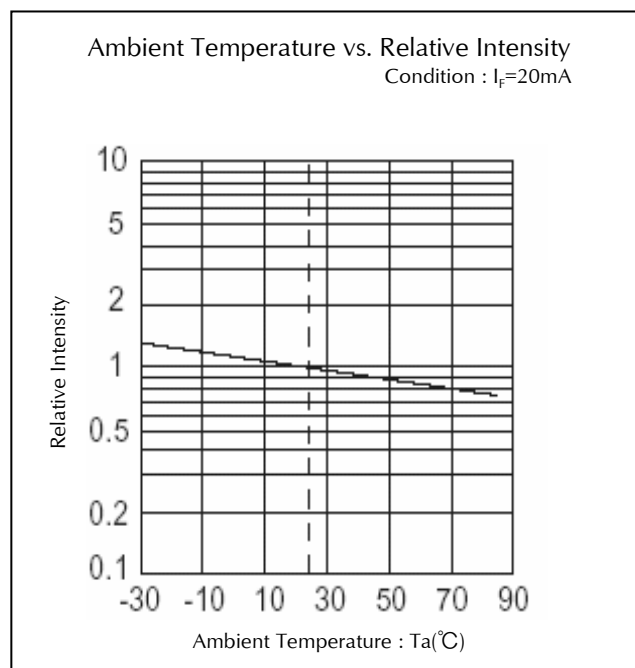
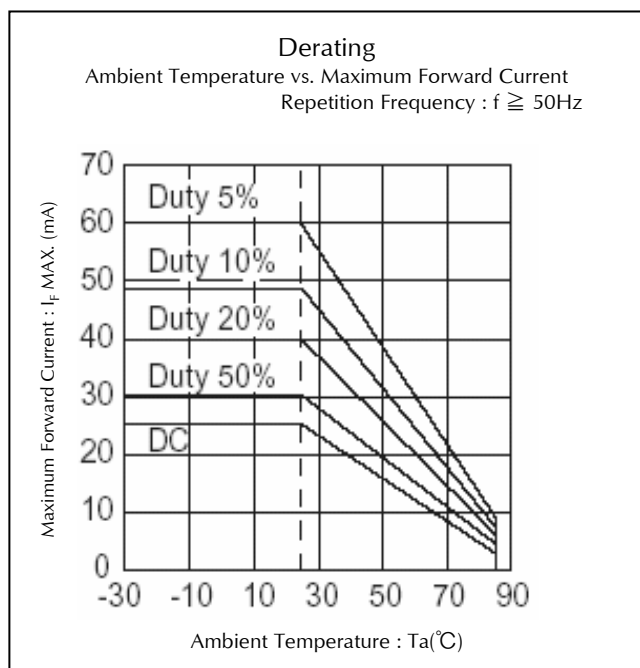
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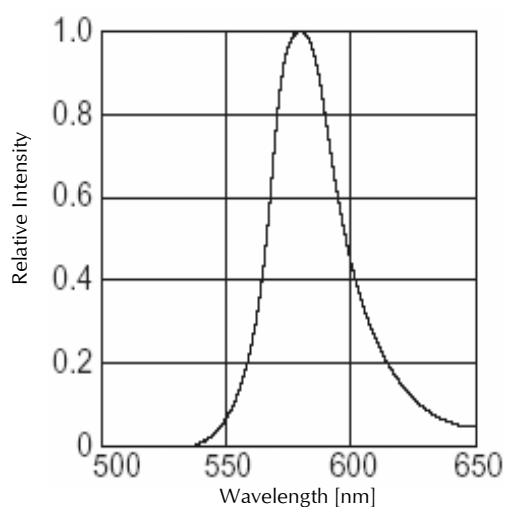


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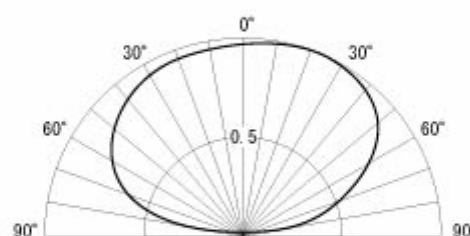
Technical Data(AY)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

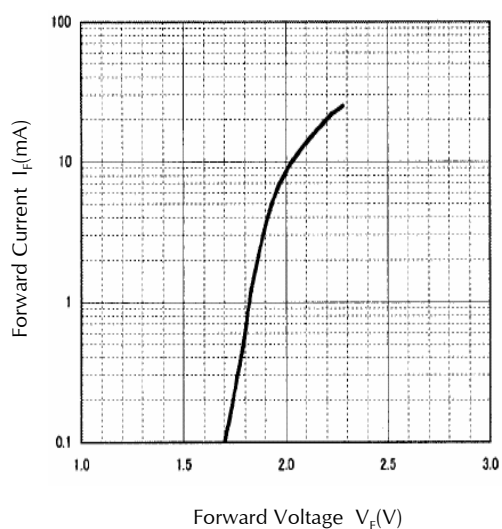


Spatial Distribution Example

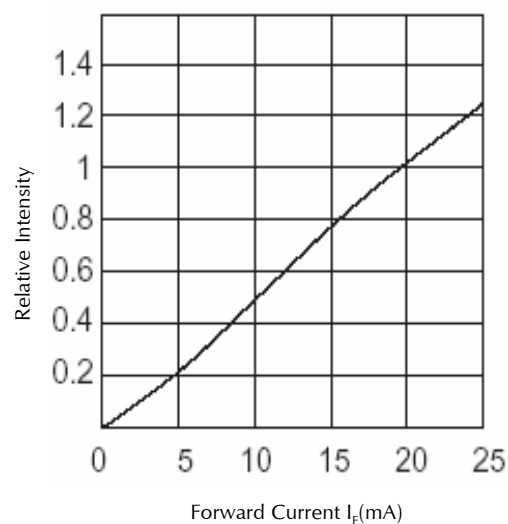
Condition : $T_a = 25^\circ\text{C}$



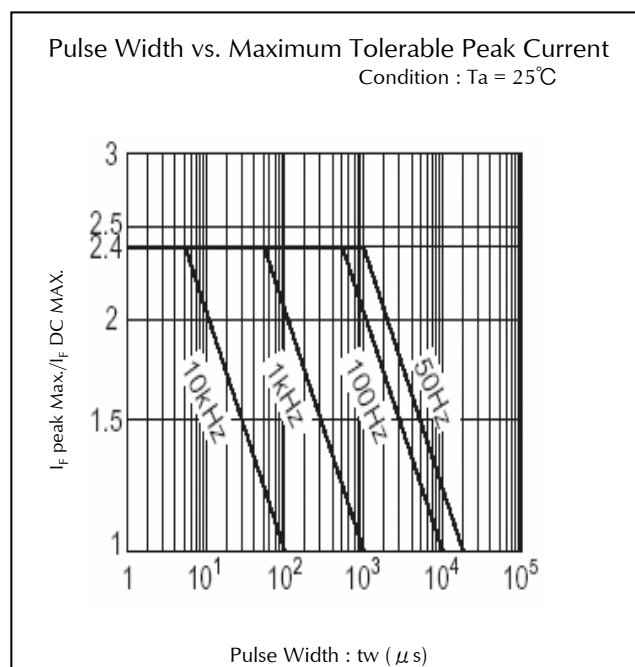
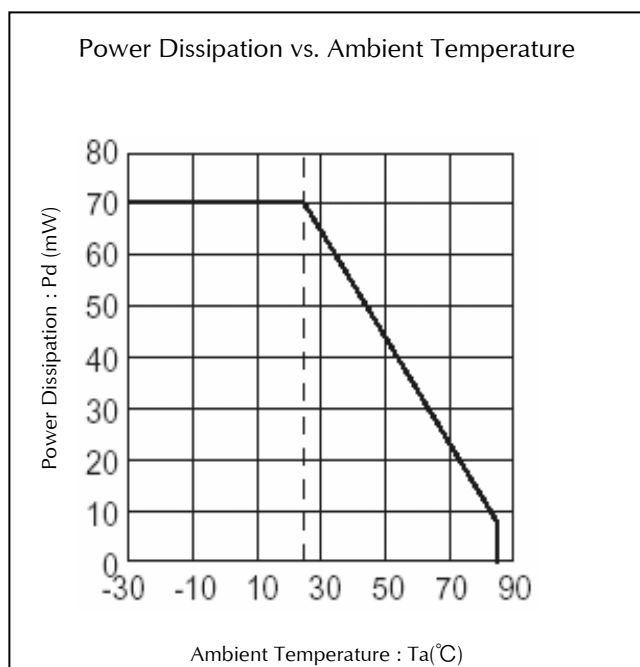
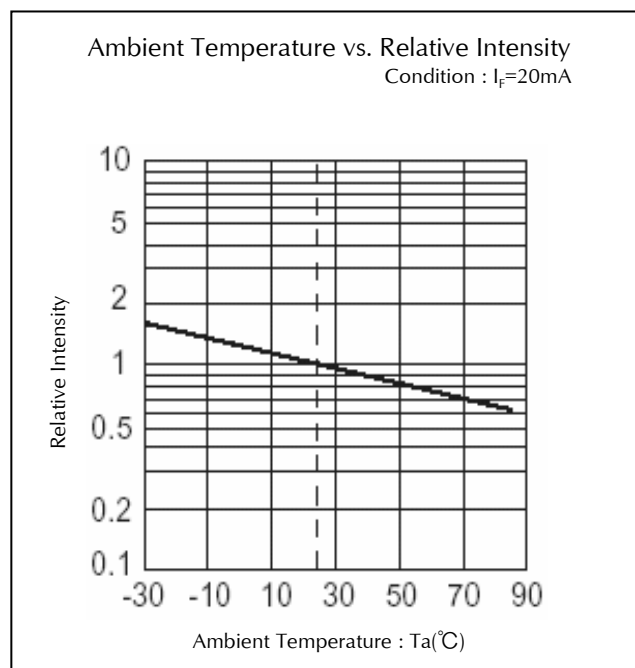
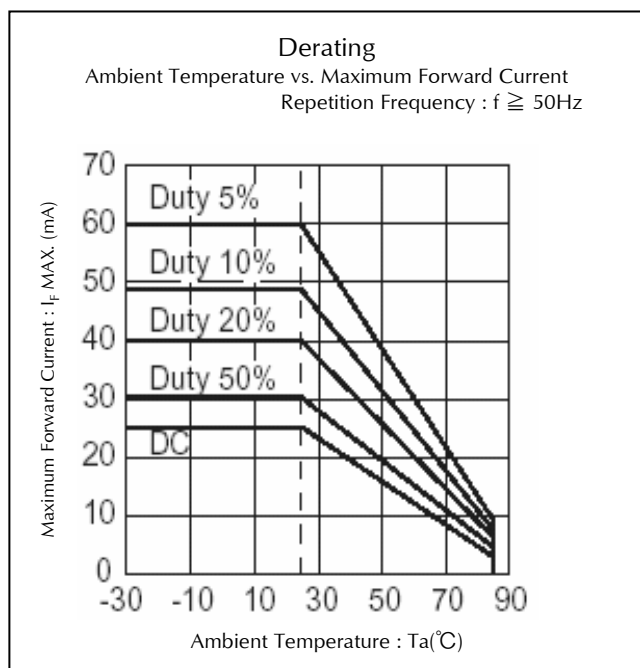
Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



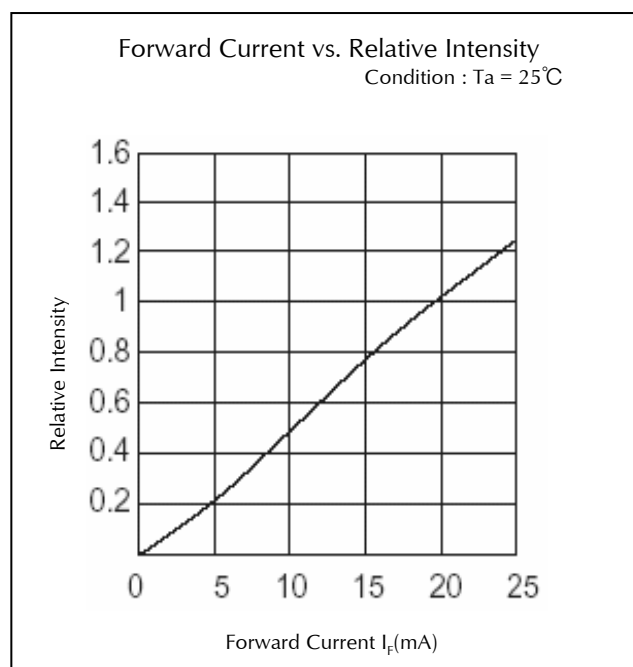
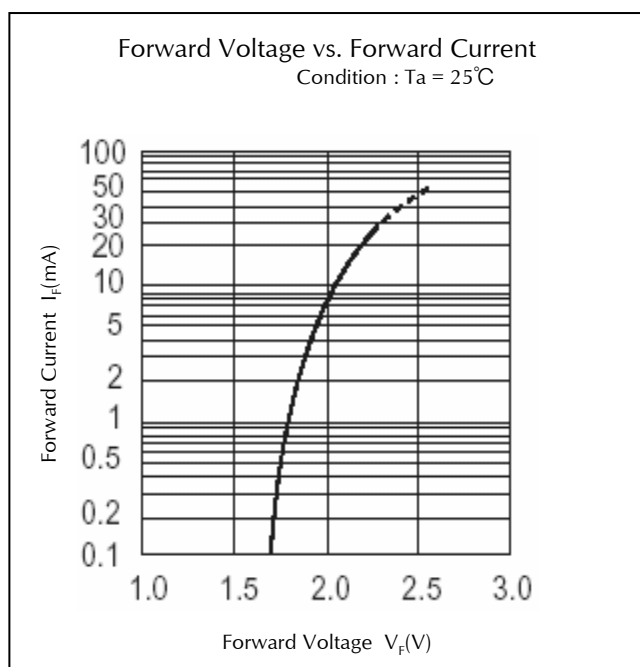
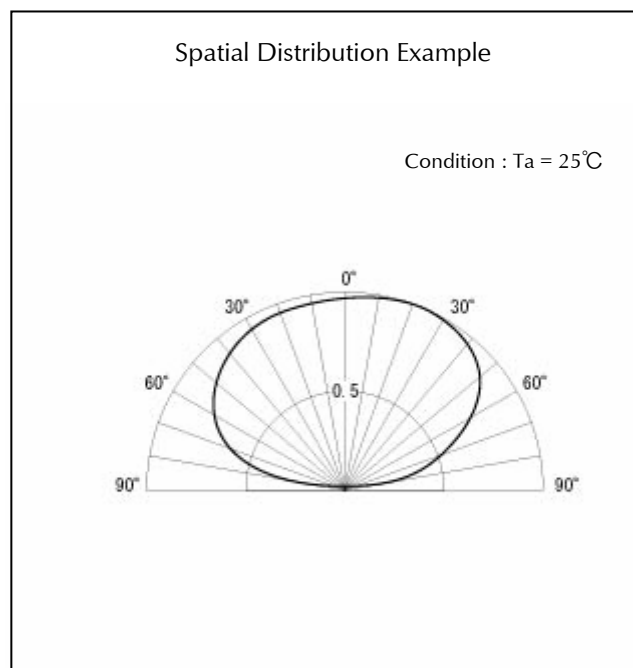
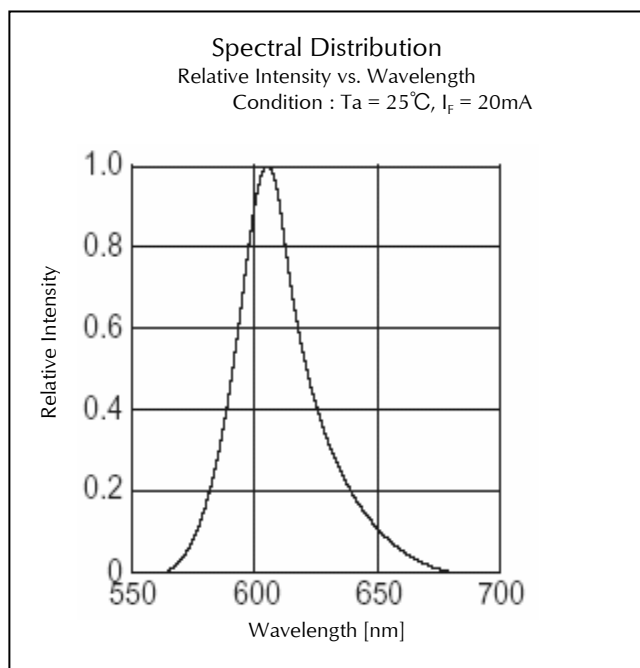
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



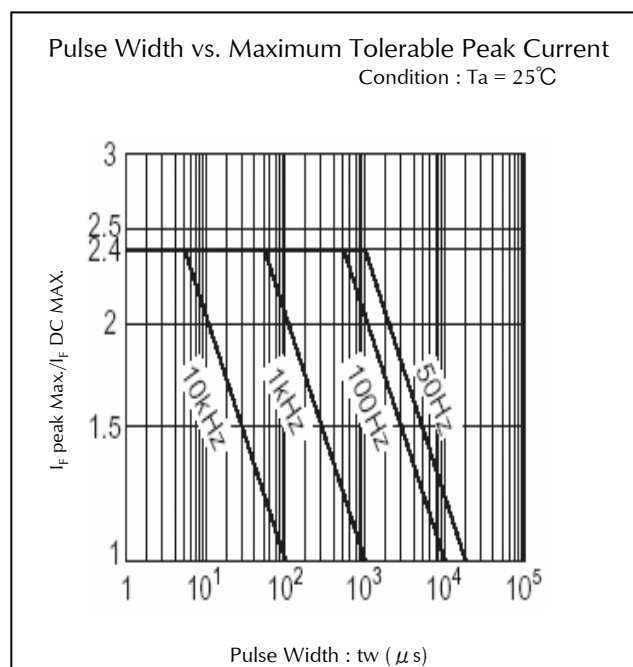
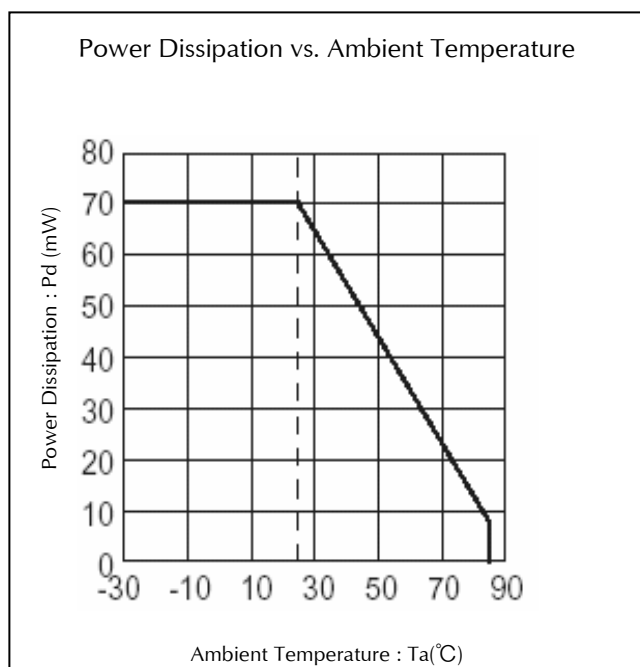
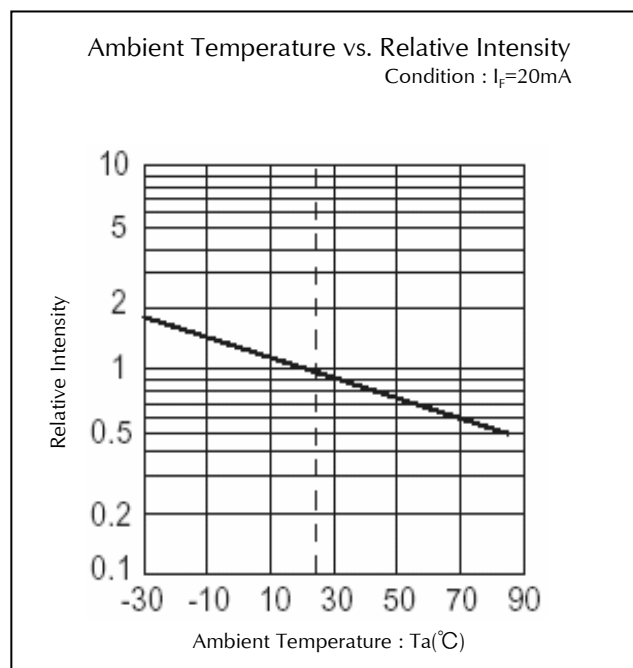
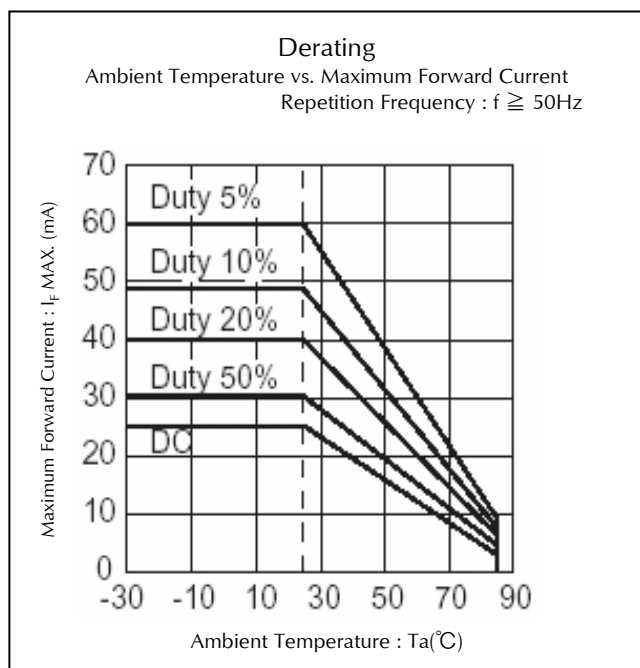
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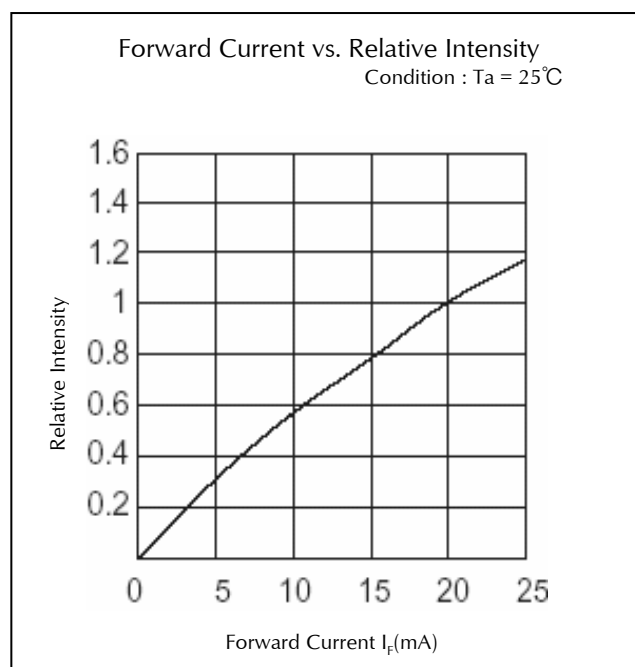
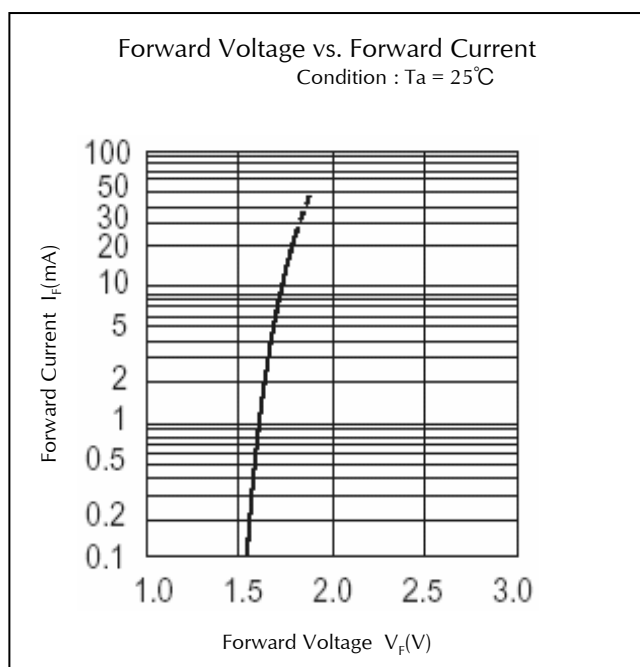
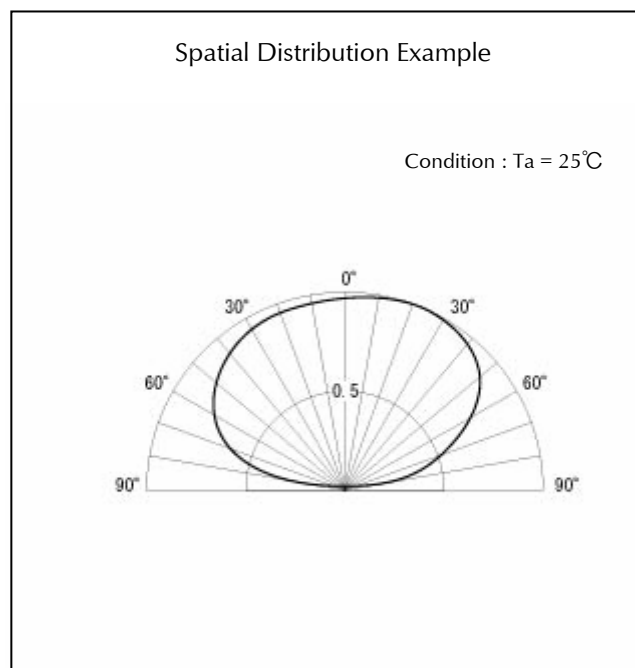
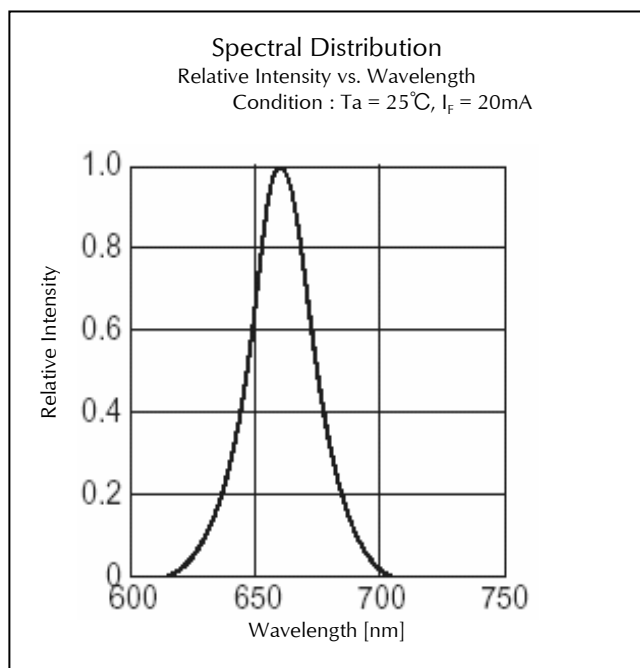
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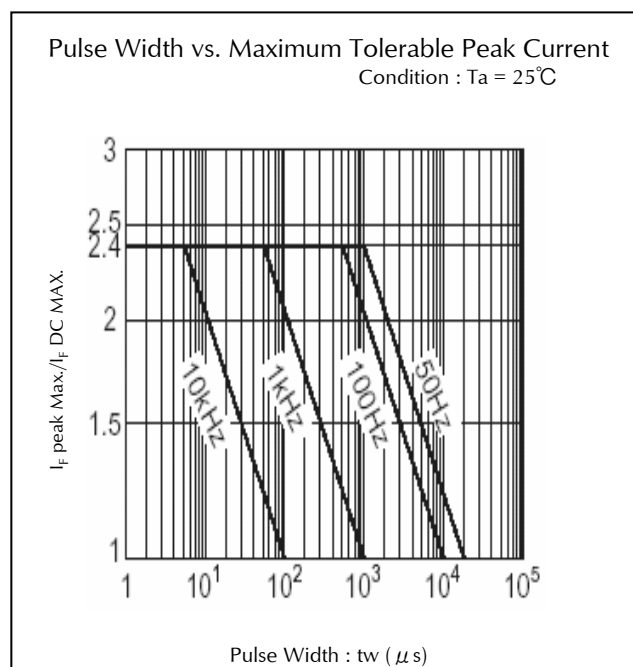
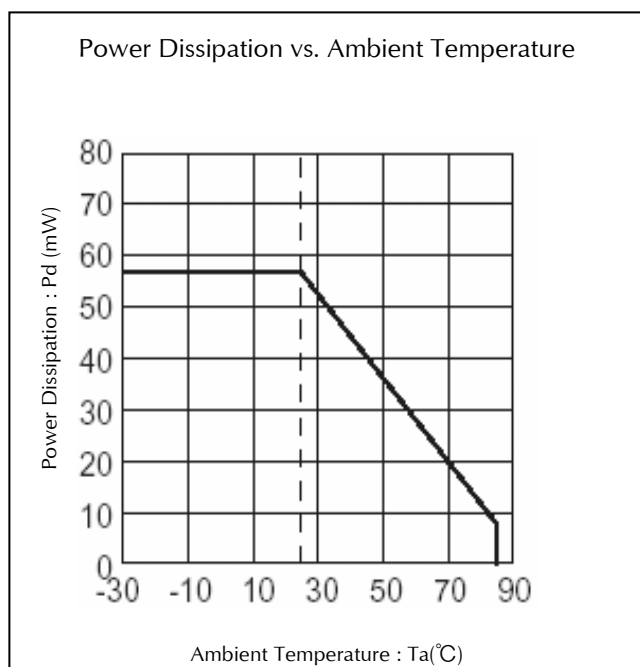
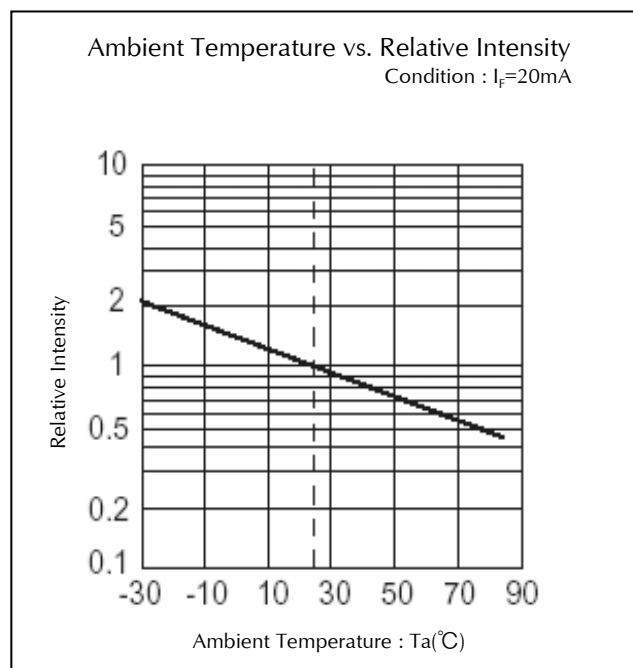
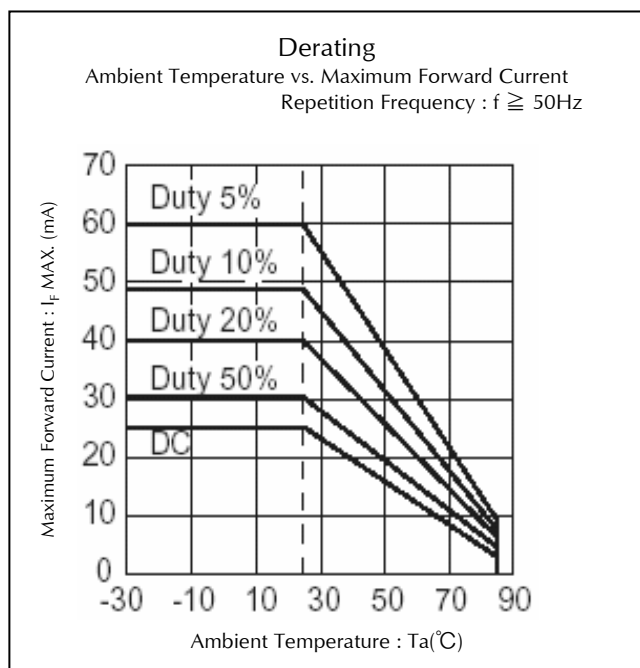
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Technical Data(BR)



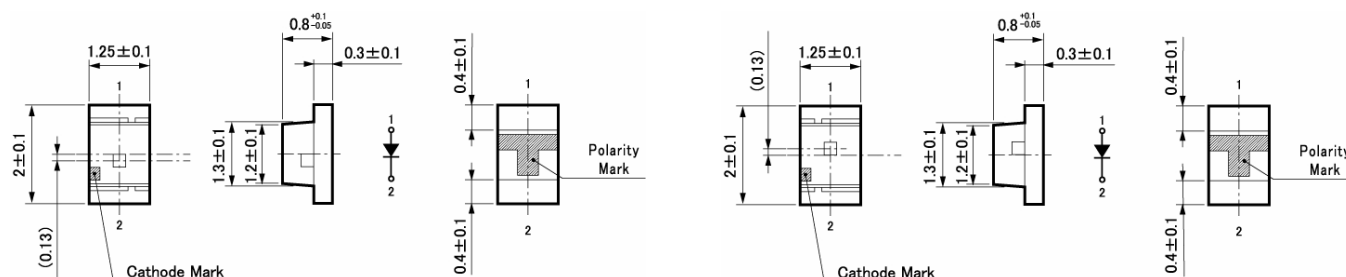
Technical Data(BR)



Package Dimensions (BG,PG,PY,AY,AA)

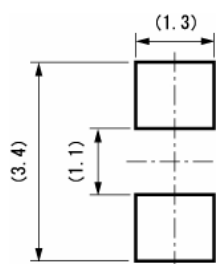
Package Dimensions (BR) (Unit: mm)

Weight: (2.84)mg



Recommended Soldering Pattern

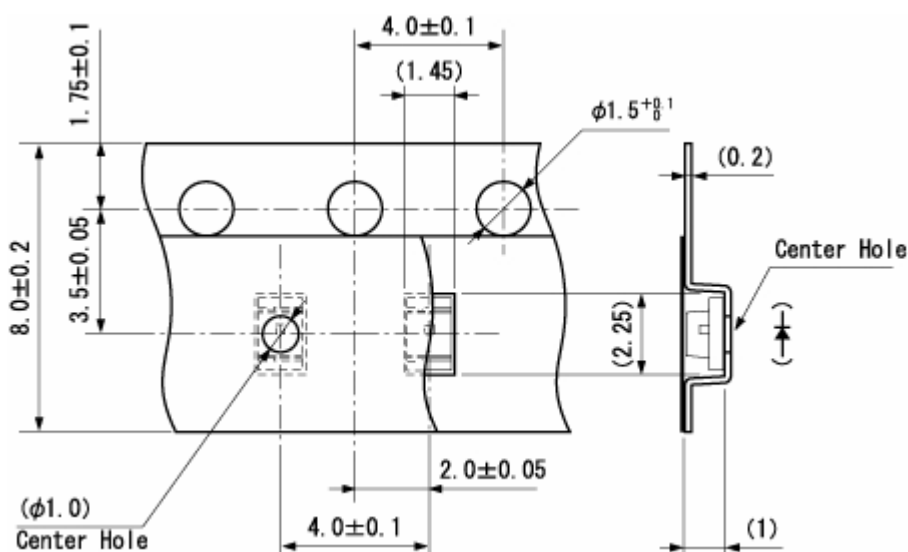
(Unit: mm)



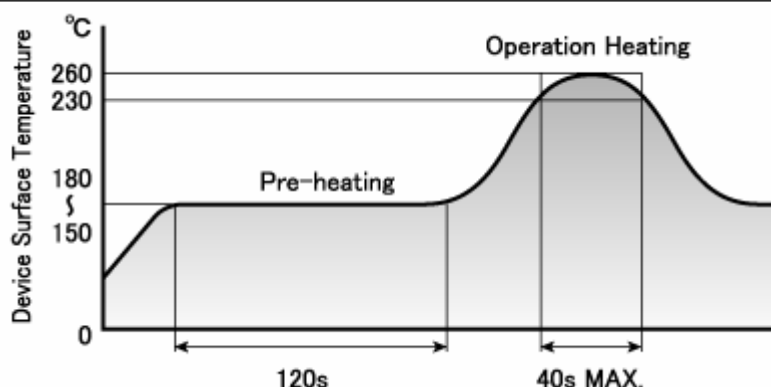
Taping Specification

(Unit: mm)

Quantity : 4,000pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6°C maximum)

TTW (Through The Wave) soldering Conditions

Pre-heating	120 °C 60 s	(MAX.) (MAX.)
Solder Bath Temp.	265 °C	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

Manual Soldering Conditions

Iron tip temp.	350 °C	(MAX.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C	5sec	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	No notable, decoloration, deformation and cracking

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